

1. General description

P-channel enhancement mode Field-Effect Transistor (FET) in an MLPAK33 (SOT8002) Surface-Mounted Device (SMD) plastic package using Trench MOSFET technology.

2. Features and benefits

- Logic level compatible
- Trench MOSFET technology
- MLPAK33 package (3.3 x 3.3 mm footprint)

3. Applications

- High-side load switch
- Battery management
- DC-to-DC conversion
- Switching circuits

4. Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
V _{DS}	drain-source voltage	T _j = 25 °C		-	-	-30	V
V _{GS}	gate-source voltage			-20	-	20	V
I _D	drain current	V _{GS} = -10 V; T _{amb} = 25 °C; t ≤ 5 s	[1]	-	-	-11.7	А
Static chara	octeristics		·	·		·	
R _{DSon}	drain-source on-state resistance	V _{GS} = -10 V; I _D = -7.4 A; T _j = 25 °C		-	13.5	18	mΩ
		V _{GS} = -4.5 V; I _D = -6.1 A; T _j = 25 °C		-	19.2	27	mΩ

[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and mounting pad for drain 6 cm².



5. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	S	source	1 2 2 4	
2	S	source	مقاقبة المستعمر	
3	S	source		
4	G	gate	Ľ Ĺ	
5	D	drain		
6	D	drain	— Церей	S 017aaa257
7	D	drain		
8	D	drain	MLPAK33 (SOT8002-1)	

6. Ordering information

Table 3. Ordering information Type number	tion Package					
	Name	Description	Version			
PXP018-30QL		plastic thermal enhanced surface mounted package; mini leads; 8 terminals; pitch 0.65 mm; 3.3 x 3.3 x 0.8 mm body	SOT8002-1			

7. Marking

Table 4. Marking codes	
Type number	Marking code
PXP018-30QL	8AC

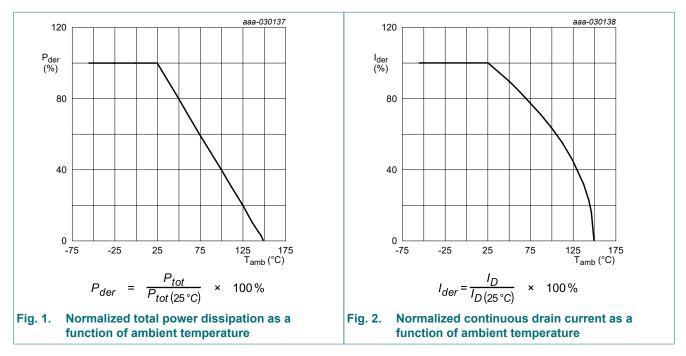
8. Limiting values

Table 5. Limiting values

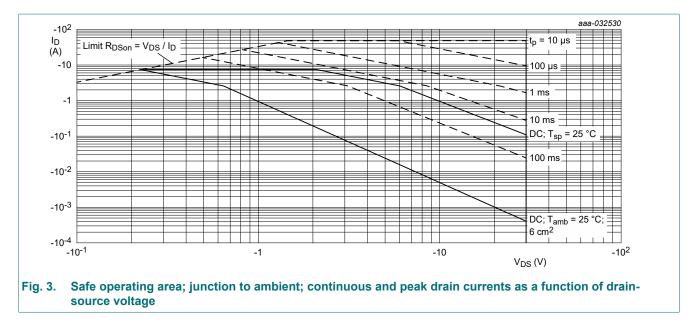
In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Max	Unit
V _{DS}	drain-source voltage	T _j = 25 °C		-	-30	V
V _{GS}	gate-source voltage	_		-20	20	V
I _D	drain current	V _{GS} = -10 V; T _{amb} = 25 °C; t ≤ 5 s	[1]	-	-11.7	А
		V _{GS} = -10 V; T _{amb} = 25 °C	[1]	-	-7.5	А
		V _{GS} = -10 V; T _{amb} = 100 °C	[1]	-	-4.7	А
		V _{GS} = -10 V; T _{sp} = 25 °C		-	-22.7	А
I _{DM}	peak drain current	T_{amb} = 25 °C; single pulse; $t_p \le 10 \ \mu s$		-	-48.3	А
P _{tot}	total power dissipation	T _{amb} = 25 °C; t ≤ 5 s	[1]	-	4.2	W
		T _{amb} = 25 °C	[1]	-	1.7	W
		T _{sp} = 25 °C		-	16	W
Tj	junction temperature			-55	150	°C
T _{amb}	ambient temperature			-55	150	°C
T _{stg}	storage temperature			-65	150	°C
Source-drain	n diode					
I _S	source current	T _{amb} = 25 °C	[1]	-	-1.7	А
		1				

[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and mounting pad for drain 6 cm².



30 V, P-channel Trench MOSFET



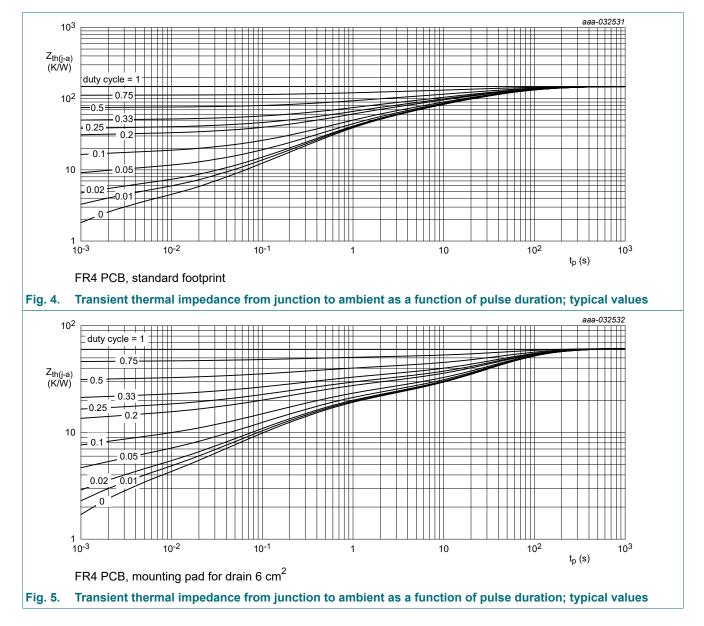
PXP018-30QL

9. Thermal characteristics

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
R _{th(j-a)}	thermal resistance from junction to ambient	in free air	[1]	-	150	190	K/W
			[2]	-	60	75	K/W
		in free air; t ≤ 5 s	[2]	-	25	30	K/W
R _{th(j-sp)}	thermal resistance from junction to solder point			-	4	8	K/W

[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

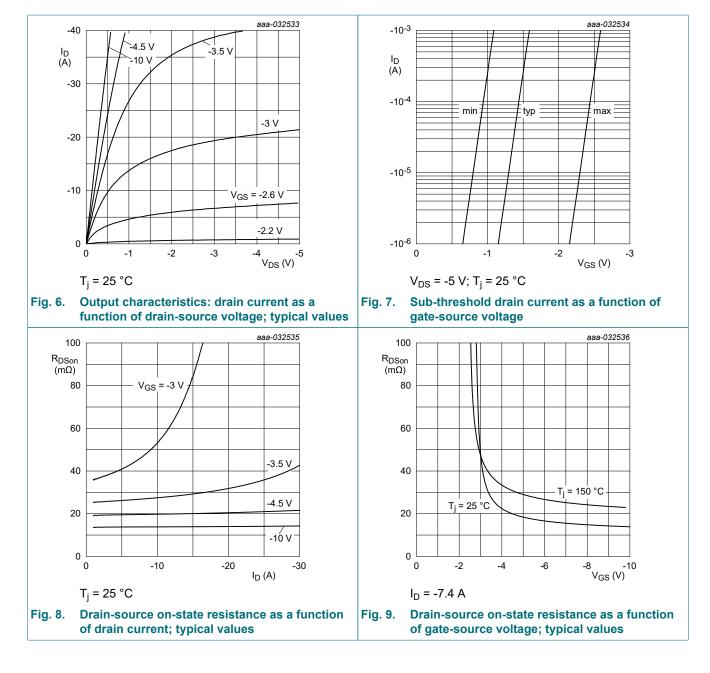
[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated and mounting pad for drain 6 cm².



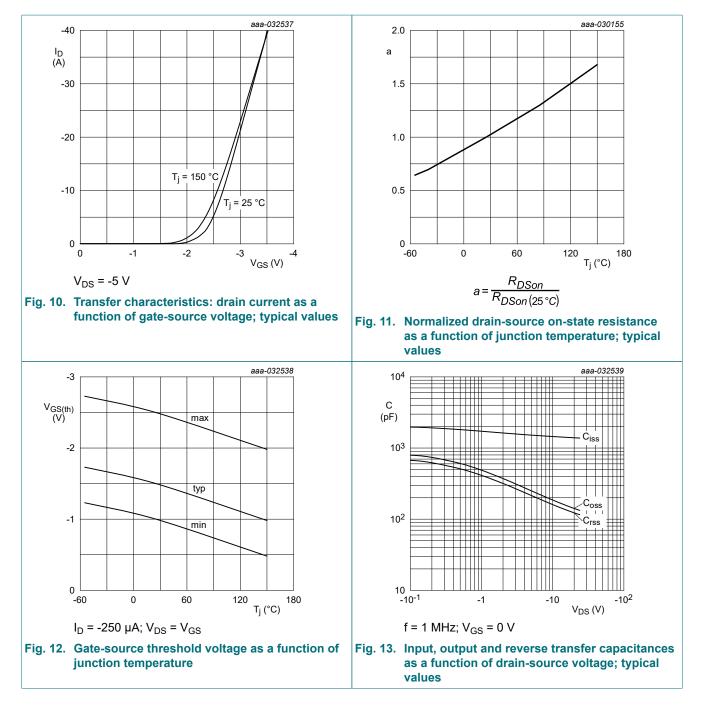
10. Characteristics

Symbol	Parameter	Conditions	Min	Тур	Мах	Unit
Static chara	cteristics					
V _{(BR)DSS}	drain-source breakdown voltage	I _D = -250 μA; V _{GS} = 0 V; T _j = 25 °C	-30	-	-	V
V _{GSth}	gate-source threshold voltage	I_D = -250 µA; V_{DS} = V_{GS} ; T_j = 25 °C	-1	-1.5	-2.5	V
I _{DSS}	drain leakage current	V _{DS} = -30 V; V _{GS} = 0 V; T _j = 25 °C	-	-	-1	μA
I _{GSS}	gate leakage current	V _{GS} = -20 V; V _{DS} = 0 V; T _j = 25 °C	-	-	-0.1	μA
		V _{GS} = 20 V; V _{DS} = 0 V; T _j = 25 °C	-	-	0.1	μA
R _{DSon}	drain-source on-state	V _{GS} = -10 V; I _D = -7.4 A; T _j = 25 °C	-	13.5	18	mΩ
	resistance	V _{GS} = -10 V; I _D = -7.4 A; T _j = 150 °C	-	22.7	30.2	mΩ
		V _{GS} = -4.5 V; I _D = -6.1 A; T _j = 25 °C	-	19.2	27	mΩ
9fs	forward transconductance	V _{DS} = -10 V; I _D = -7.4 A; T _j = 25 °C	-	35	-	S
R _G	gate resistance	f = 1 MHz	-	9	-	Ω
Dynamic ch	aracteristics	· · · · ·	I			
Q _{G(tot)}	total gate charge	V_{DS} = -15 V; I _D = -7.4 A; V _{GS} = -10 V; T _j = 25 °C	-	29.4	44.1	nC
		V _{DS} = -15 V; I _D = -6.1 A; V _{GS} = -4.5 V;	-	14.7	22.1	nC
Q _{GS}	gate-source charge	T _j = 25 °C	-	3.5	-	nC
Q _{GS(th)}	pre-threshold gate- source charge		-	2	-	nC
Q _{GS(th-pl)}	post-threshold gate- source charge		-	1.5	-	nC
Q _{GD}	gate-drain charge	1 –	-	6.2	-	nC
V _{GSpl}	gate-source plateau voltage	V _{DS} = -15 V; I _D = -6.1 A; T _j = 25 °C	-	-2.6	-	V
C _{iss}	input capacitance	V _{DS} = -15 V; f = 1 MHz; V _{GS} = 0 V;	-	1420	-	pF
C _{oss}	output capacitance	T _j = 25 °C	-	160	-	pF
C _{rss}	reverse transfer capacitance		-	140	-	pF
t _{d(on)}	turn-on delay time	V _{DS} = -15 V; I _D = -6.1 A; V _{GS} = -4.5 V;	-	8	-	ns
t _r	rise time	$R_{G(ext)} = 5 \Omega; T_j = 25 °C$	-	40	-	ns
t _{d(off)}	turn-off delay time	1 –	-	33	-	ns
t _f	fall time	1 –	-	25	-	ns
Source-drai	n diode		I			
V _{SD}	source-drain voltage	I _S = -1.7 A; V _{GS} = 0 V; T _j = 25 °C	-	-0.8	-1.2	V
t _{rr}	reverse recovery time	I _S = -1.7 A; dI _S /dt = 100 A/μs;	-	17	-	ns
Q _r	recovered charge	V _{GS} = -4.5 V; V _{DS} = -15 V; T _j = 25 °C	-	6	-	nC
t _a	reverse recovery rise time		-	8	-	ns
t _b	reverse recovery fall time		-	9	-	ns

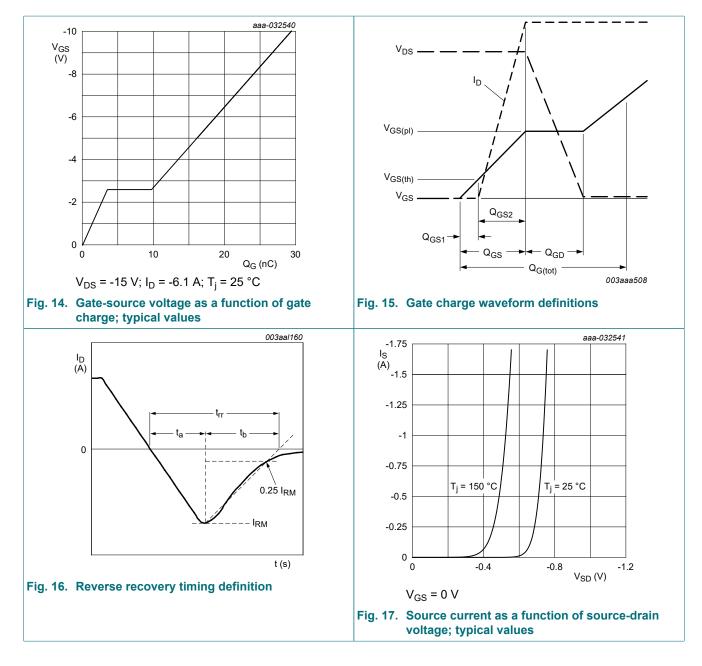
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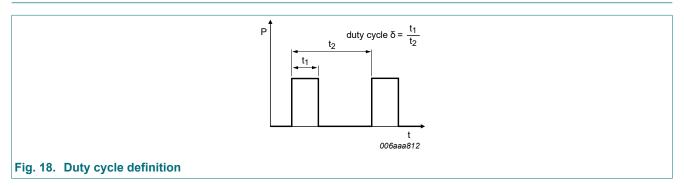
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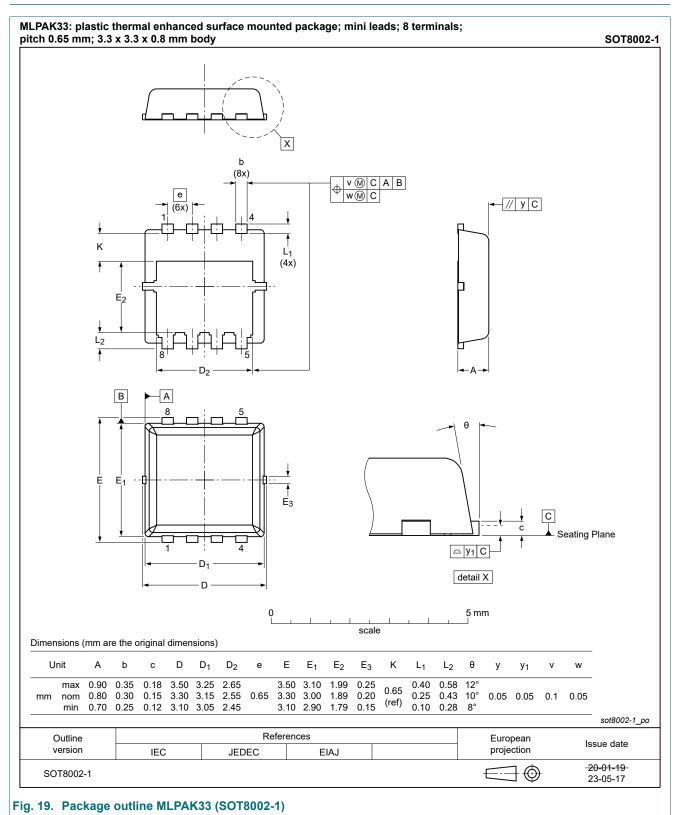


11. Test information

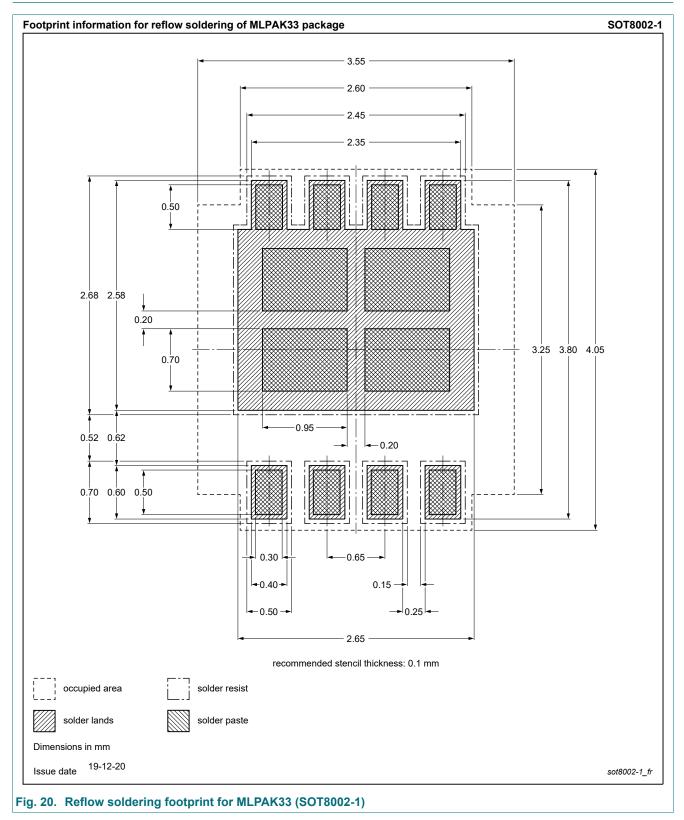


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12. Package outline



13. Soldering



14. Revision history

Table 8. Revision history							
Data sheet ID	Release date	Data sheet status	Change notice	Supersedes			
PXP018-30QL v.2	20230731	Product data sheet	-	PXP018-30QL v.1			
Modifications:	Chapter "Package of	Chapter "Package outline": drawing update					
PXP018-30QL v.1	20220124	Product data sheet	-	-			

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15. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

 Please consult the most recently issued document before initiating or completing a design.

- [2] The term 'short data sheet' is explained in section "Definitions".
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